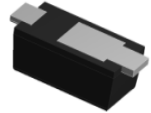
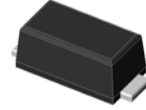


Features

- Heatsink structure
- Low profile, typical thickness 0.8mm
- Super Low VF Schottky barrier diodes
- Moisture sensitivity: level 1, per J-STD-020
- High temperature soldering guaranteed: 260°C/10 seconds



RoHS
COMPLIANT



iSGA
(SOD-123HS)

Typical Applications

For use of fast switching in RF module, lighting, cellular phone, portable device, power supplies and other consumer applications.

Maximum Ratings (TA = 25 °C unless otherwise noted)

Parameter	Symbol	PS32	PS33	PS34	PS345	Unit
Maximum repetitive peak reverse voltage	VRRM	20	30	40	45	V
Maximum RMS voltage	VRMS	14	21	28	31.5	V
Maximum DC blocking voltage	VDC	20	30	40	45	V
Maximum average forward rectified current	IF(AV)	3.0				A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	IFSM	100				A
Rating for fusing(t<8.3ms)	I ² t	42				A ² sec
Operating junction temperature range	T _J	- 55 to + 150				°C
Storage temperature range	T _{STG}	- 55 to + 150				°C

Electrical Characteristics (TA = 25 °C unless otherwise noted)

Parameter	Test Conditions	Symbol	PS32	PS33	PS34	PS345	Unit
Minimum Breakdown voltage	Ta=25°C,IR=1mA	V _{BR}	45				Volts
Maximum instantaneous forward voltage	IF=3A,Ta=25°C	V _F	0.51				
	IF=3A,Ta=125°C		0.45				
Maximum DC reverse current at rated DC blocking voltage	Ta=25°C	I _R	50				uA
	Ta=125°C		10				mA
Typical junction capacitance	4.0 V, 1 MHz	C _J	229				pF
Typical thermal resistance	juntion to ambient	R _{θJA} ¹⁾	60				°C/W
	juntion to lead	R _{θJL} ¹⁾	6				
	juntion to case	R _{θJC} ²⁾	28				

Note:1),The thermal resistance from junction to ambient or lead, mounted on P.C.B with 5×5mm copper pads,2 OZ,FR4 PCB

2),The thermal resistance from junction to case, mounted on P.C.B with recommended copper pads,2 OZ,FR4 PCB

Ratings and Characteristics Curves

(TA = 25°C unless otherwise noted)

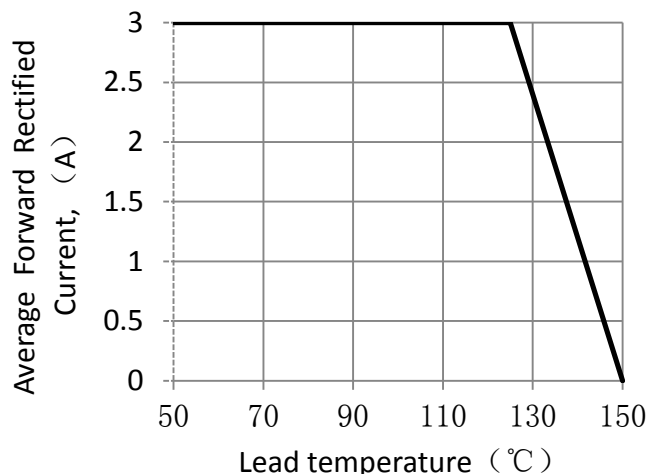


Figure 1. Forward Current Derating Curve

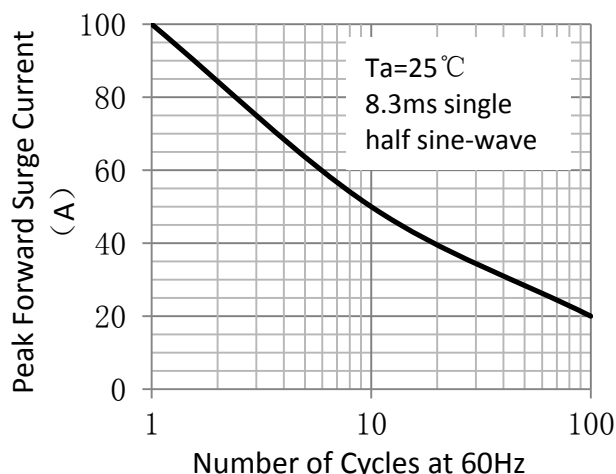


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

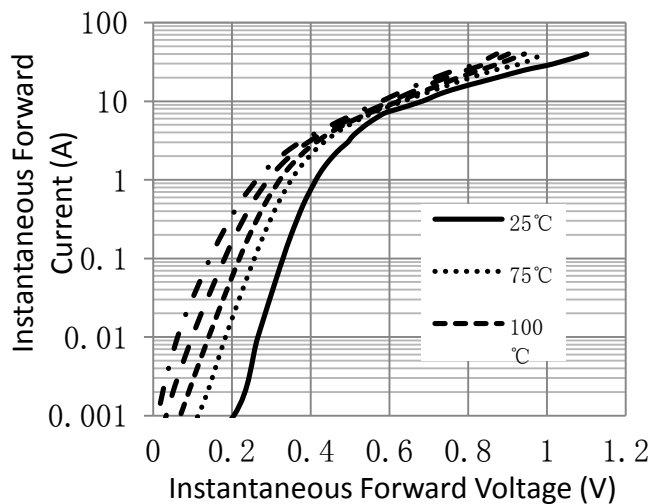


Figure 3. Typical Instantaneous Forward Characteristics

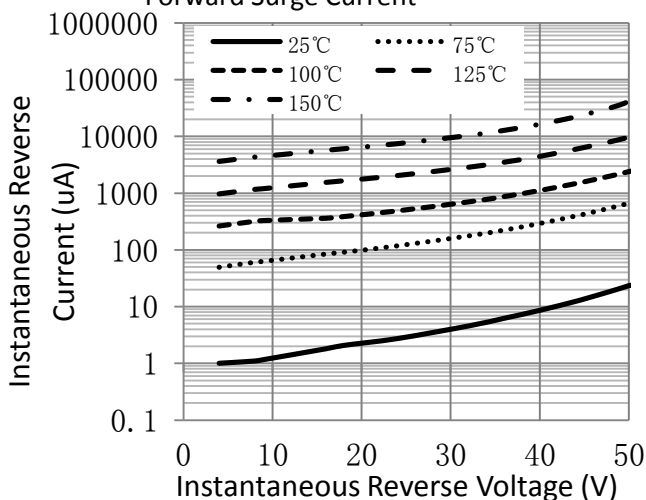


Figure 4. Typical Reverse Characteristics

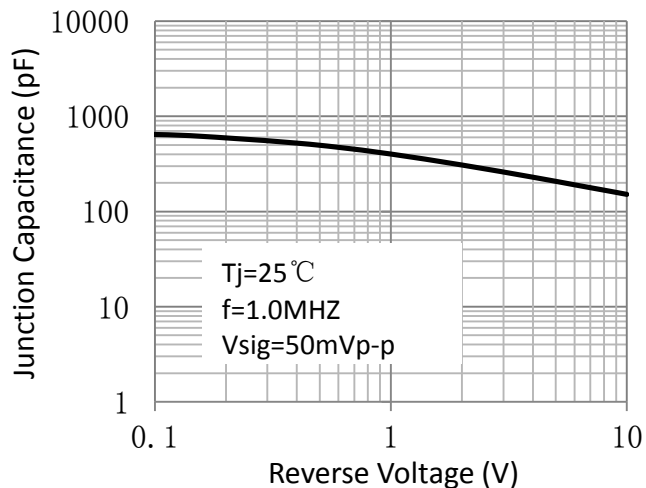
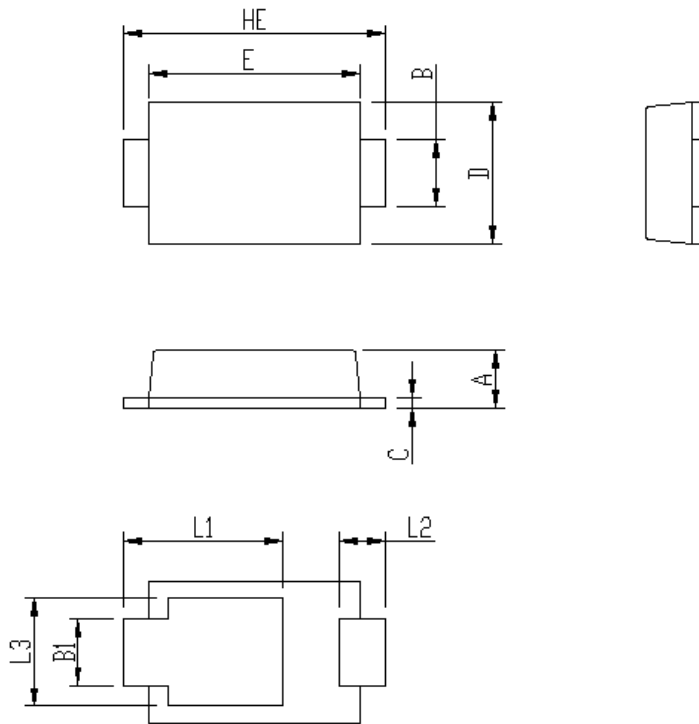


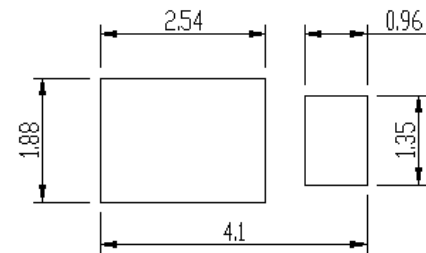
Figure 5. Typical Junction Capacitance

Package Outline Dimensions



Package	iSGA	
Unit:mm	MIN	MAX
A	0.75	0.90
B	0.85	1.05
B1	0.85	1.05
C	0.1	0.25
D	1.9	2.1
E	2.9	3.1
L1	2.0	2.45
L2	0.4	0.85
L3	1.3	1.7
HE	3.5	3.9

Soldering footprint

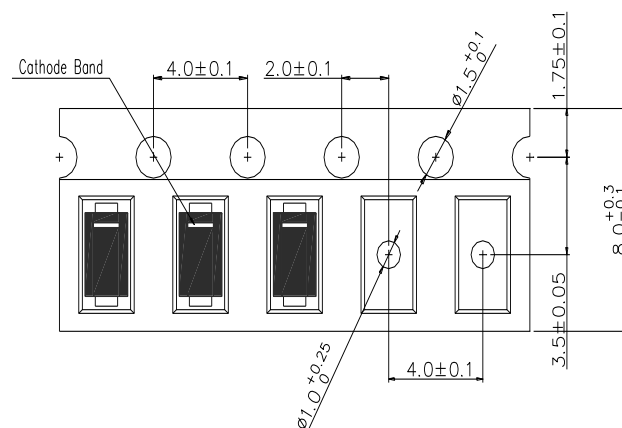


Packing Information

Packing quantities:

Reel size	Quantity/reel	Quantity/inner Box	Quantity/Carton
7"	3K	30K	120K
13"	10K	20K	180K

Tape & Reel Specification





PS32 thru PS345

Surface Mount Schottky Rectifier

Reverse Voltage 20~45V Forward Current 3.0A

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